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# LM4674 Boomer® Audio Power Amplifier Series Filterless 2.5W Stereo Class D Audio Power **Amplifier**

Check for Samples: LM4674

## **FEATURES**

- **Output Short Circuit Protection**
- **Stereo Class D Operation**
- No Output Filter Required
- Logic Selectable Gain
- **Independent Shutdown Control**
- Minimum External Components
- **Click and Pop Suppression**
- Micro-Power Shutdown
- Available in Space-Saving 2mm x 2mm x 0.6mm DSBGA, and 4mm x 4mm x 0.8mm **WQFN Packages**

## **APPLICATIONS**

- **Mobile Phones**
- **PDAs**
- Laptops

# **KEY SPECIFICATIONS**

- Efficiency at 3.6V, 100mW into  $8\Omega$ : 80% (typ)
- Efficiency at 3.6V, 500mW into 8 $\Omega$ : 85% (typ)
- Efficiency at 5V, 1W into 8Ω: 85% (typ)
- **Quiescent Power Supply Current** at 3.6V supply: 4mA
- Power Output at  $V_{DD} = 5V$ ,

 $R_1 = 4\Omega$ , THD  $\leq 10\%$ : 2.5 W (typ)

Shutdown Current: 0.03µA (typ)

#### DESCRIPTION

The LM4674 is a single supply, high efficiency, 2.5W/channel, filterless switching audio amplifier. A low noise PWM architecture eliminates the output filter, reducing external component count, board area consumption, system cost, and simplifying design.

The LM4674 is designed to meet the demands of mobile phones and other portable communication devices. Operating from a single 5V supply, the device is capable of delivering 2.5W/channel of continuous output power to a  $4\Omega$  load with less than 10% THD+N. Flexible power supply requirements allow operation from 2.4V to 5.5V.

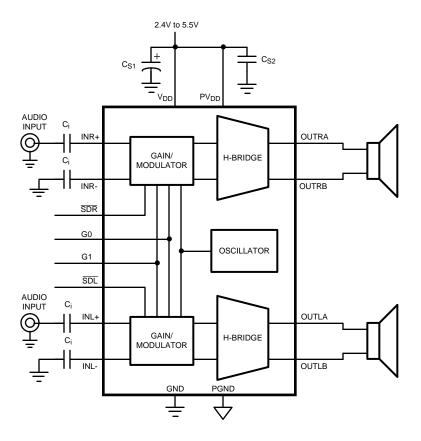
The LM4674 features high efficiency compared to conventional Class AB amplifiers. When driving an  $8\Omega$  speaker from a 3.6V supply, the device features 85% efficiency at  $P_0 = 500$ mW. Four gain options are pin selectable through the G0 and G1 pins.

Output short circuit protection prevents the device from being damaged during fault conditions. Superior click and pop suppression eliminates audible transients on power-up/down and during shutdown. Independent left/right shutdown control maximizes power savings in mixed mono/stereo applications.

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## **TYPICAL APPLICATION**



 $C_{i} = 1 \mu F$   $C_{S1} = 1 \mu F$   $C_{S2} = 0.1 \mu F$ 

Figure 1. Typical Audio Amplifier Application Circuit

# **EXTERNAL COMPONENTS DESCRIPTION**

# (Figure 1)

Components		Functional Description
1.	C <sub>S</sub>	Supply bypass capacitor which provides power supply filtering. Refer to the AUDIO AMPLIFIER INPUT CAPACITOR SELECTION section for information concerning proper placement and selection of the supply bypass capacitor.
2.	C <sub>i</sub>	Input AC coupling capacitor which blocks the DC voltage at the amplifier's input terminals.



# **CONNECTION DIAGRAM**

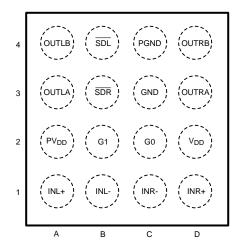


Figure 2. DSBGA (Top View) See YZR0016 Package

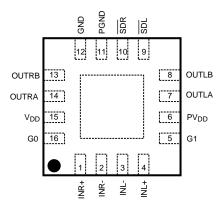


Figure 3. WQFN (Top View) See RGH0016A Package



## PIN DESCRIPTION

BUMP	PIN	NAME	FUNCTION
A1	4	INL+	Non-inverting left channel input
A2	6	$PV_{DD}$	Power V <sub>DD</sub>
A3	7	OUTLA	Left channel output A
A4	8	OUTLB	Left channel output B
B1	3	INL-	Inverting left channel input
B2	5	G1	Gain setting input 1
B3	10	SDR	Right channel shutdown input
B4	9	SDL	Left channel shutdown input
C1	2	INR-	Inverting right channel input
C2	16	G0	Gain setting input 0
C3	12	GND	Ground
C4	11	PGND	Power Ground
D1	1	INR+	Non-inverting right channel input
D2	15	$V_{DD}$	Power Supply
D3	14	OUTRA	Right channel output A
D4	13	OUTRB	Right channel output B



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.



# ABSOLUTE MAXIMUM RATINGS(1)(2)

Supply Voltage <sup>(1)</sup>		6.0V
Storage Temperature	−65°C to +150°C	
Input Voltage	-0.3V to V <sub>DD</sub> +0.3V	
Power Dissipation (3)	Internally Limited	
ESD Susceptibility, all other pins (4)	2000V	
ESD Susceptibility <sup>(5)</sup>		200V
Junction Temperature (T <sub>JMAX</sub> )		150°C
Thermal Resistance	θ <sub>JA</sub> (DSBGA)	45.7°C/W
	θ <sub>JA</sub> (WQFN)	38.9°C/W

- (1) All voltages are measured with respect to the ground pin, unless otherwise specified.
- (2) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which ensure specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not ensured for parameters where no limit is given, however, the typical value is a good indication of device performance.
- (3) The maximum power dissipation must be derated at elevated temperatures and is dictated by T<sub>JMAX</sub>, θ<sub>JA</sub>, and the ambient temperature, T<sub>A</sub>. The maximum allowable power dissipation is P<sub>DMAX</sub> = (T<sub>JMAX</sub> T<sub>A</sub>)/ θ<sub>JA</sub> or the number given in Absolute Maximum Ratings, whichever is lower. For the LM4674 see power derating currents for more information.
- (4) Human body model, 100pF discharged through a  $1.5k\tilde{\Omega}$  resistor.
- (5) Machine Model, 220pF-240pF discharged through all pins.

## OPERATING RATINGS(1)(2)

Temperature Range ( $T_{MIN} \le T_A \le T_{MAX}$ )	-40°C ≤ T <sub>A</sub> ≤ 85°C
Supply Voltage	$2.4V \le V_{DD} \le 5.5V$

- (1) All voltages are measured with respect to the ground pin, unless otherwise specified.
- Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which ensure specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not ensured for parameters where no limit is given, however, the typical value is a good indication of device performance.

# ELECTRICAL CHARACTERISTICS $V_{DD} = 3.6V^{(1)(2)}$

The following specifications apply for  $A_V$  = 6dB,  $R_L$  = 15 $\mu$ H + 8 $\Omega$  + 15 $\mu$ H, f = 1kHz unless otherwise specified. Limits apply for  $T_A$  = 25°C.

0	B	O a markita a a a	LM4	Units	
Symbol	Parameter	Conditions	Typical <sup>(3)</sup>	Limit <sup>(4)(5)</sup>	(Limits)
Vos	Differential Output Offset Voltage	$V_{IN} = 0$ , $V_{DD} = 2.4V$ to 5.0V	5		mV
		$V_{IN} = 0$ , $R_L = \infty$ , Both channels active, $V_{DD} = 3.6V$	4	6	mA
I <sub>DD</sub> Quiescent Power Supply Current	$V_{IN} = 0$ , $R_L = \infty$ , Both channels active, $V_{DD} = 5V$	5	7.5	mA	
I <sub>SD</sub>	Shutdown Current	$V \overline{SDR} = V \overline{SDL} = GND$	0.03	1	μA
$V_{SDIH}$	Shutdown Voltage Input High			1.4	V (min)
V <sub>SDIL</sub>	Shutdown Voltage Input Low			0.4	V (max)
T <sub>WU</sub>	Wake Up Time	$V \overline{SDR/SDL} = 0.4V$	0.5		ms

- (1) All voltages are measured with respect to the ground pin, unless otherwise specified.
- (2) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which ensure specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not ensured for parameters where no limit is given, however, the typical value is a good indication of device performance.
- (3) Typicals are measured at 25°C and represent the parametric norm.
- 4) Limits are specified to AOQL (Average Outgoing Quality Level).
- (5) Datasheet min/max specification limits are specified by design, test, or statistical analysis.

Product Folder Links: LM4674



# ELECTRICAL CHARACTERISTICS $V_{DD} = 3.6V^{(1)(2)}$ (continued)

The following specifications apply for  $A_V = 6dB$ ,  $R_L = 15\mu H + 8\Omega + 15\mu H$ , f = 1kHz unless otherwise specified. Limits apply for  $T_A = 25^{\circ}C$ .

Symbol	Parameter	Conditions			Units			
-,			Typical <sup>(3)</sup>	Limit <sup>(4)(5)</sup>	(Limits)			
		G0, G1 = GND R <sub>L</sub> = ∞	6	6 ± 0.5	dB			
$A_V$	Gain	$G0 = V_{DD}$ , $G1 = GND$ $R_L = \infty$	12	12 ± 0.5	dB			
٦٧	Gairi	$G0 = GND$ , $G1 = V_{DD}$ $R_L = \infty$	18	18 ± 0.5	dB			
		$G0, G1 = V_{DD}$ $R_L = \infty$	24	24 ± 0.5	dB			
		$A_V = 6dB$	28		kΩ			
5	Input Pagistanes	$A_V = 12dB$	18.75		kΩ			
$R_{IN}$	Input Resistance	$A_V = 18dB$	11.25		kΩ			
		$A_V = 24dB$	31 = GND		kΩ			
		$R_L$ = 15µH + 4 $\Omega$ + 15µH, THD ≤ 10% f = 1kHz, 22kHz BW						
		$V_{DD} = 5V$	2.5		W			
		V <sub>DD</sub> = 3.6V	1.2		W			
		V <sub>DD</sub> = 2.5V	0.530		W			
		$R_L$ = 15μH + 8Ω + 15μH, THD ≤ 10% f = 1kHz, 22kHz BW						
		$V_{DD} = 5V$	1.5		W			
	Output Power	V <sub>DD</sub> = 3.6V	0.78	0.6	W			
_		$V_{DD} = 2.5V$	0.350		W			
P <sub>O</sub>		$R_L = 15\mu H + 4\Omega + 15\mu H$ , THD $\leq 1\%$ f = 1kHz, 22kHz BW						
		$V_{DD} = 5V$	1.9		W			
		$V_{DD} = 3.6V$	1		W			
		V <sub>DD</sub> = 2.5V	0.430		W			
		$R_L$ = 15 $\mu$ H + 8 $\Omega$ + 15 $\mu$ H, THD = 1% f = 1kHz, 22kHz BW						
		$V_{DD} = 5V$	1.25		W			
		V <sub>DD</sub> = 3.6V	0.63		W			
		$V_{DD} = 2.5V$	0.285		W			
ΓHD+N	Total Harmonic Distortion	$P_O = 500$ mW, $f = 1$ kHz, $RL = 8\Omega$	0.07		%			
א+טווו	Total Haimonic Distortion	$P_O = 300$ mW, $f = 1$ kHz, $RL = 8\Omega$	0.05		%			
DCDD	Paragraphic Paristina Paris	$V_{RIPPLE} = 200 \text{mV}_{P-P}$ Sine, $f_{RIPPLE} = 217 \text{Hz}$ , Inputs AC GND, $C_i = 1 \mu \text{F}$ , input referred	75		dB			
PSRR	Power Supply Rejection Ratio	$V_{RIPPLE}$ = 1 $V_{P.P}$ Sine, $f_{RIPPLE}$ = 1 $K$ Hz, Inputs AC GND, $C_i$ = 1 $\mu$ F, input referred	75		dB			
CMRR	Common Mode Rejection Ratio	$V_{RIPPLE} = 1V_{P-P}$ $f_{RIPPLE} = 217Hz$	67		dB			
1	Efficiency	$P_O = 1W$ , $f = 1kHz$ , $R_L = 8\Omega$ , $V_{DD} = 5V$	85		%			
Ktalk	Crosstalk	P <sub>O</sub> = 500mW, f = 1kHz	84		dB			
SNR	Signal to Noise Ratio	V <sub>DD</sub> = 5V, P <sub>O</sub> = 1W	96		dB			
os	Output Noise	Input referred, A-Weighted Filter	20		μV			



# **BLOCK DIAGRAMS**

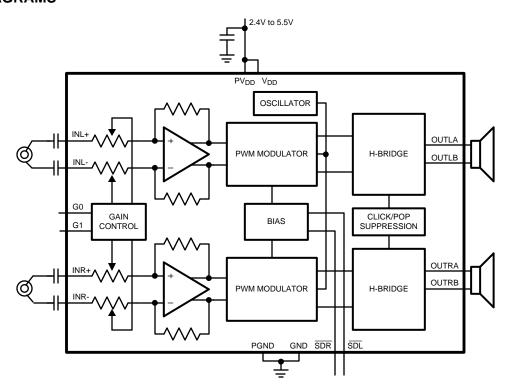


Figure 4. Differential Input Configuration

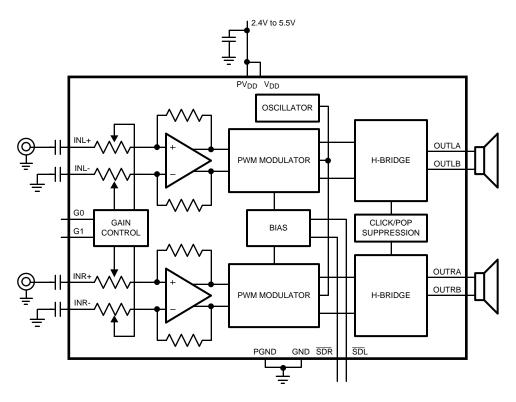
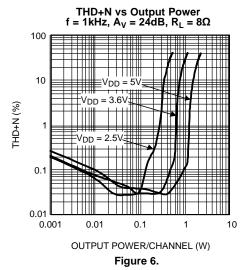
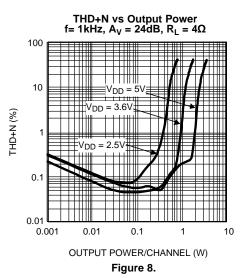
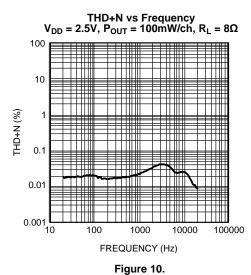


Figure 5. Single-Ended Input Configuration

#### TYPICAL PERFORMANCE CHARACTERISTICS







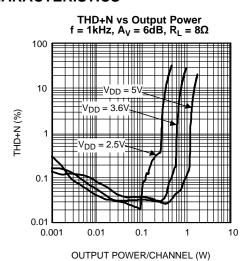
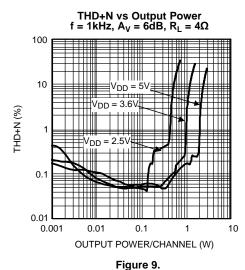


Figure 7.



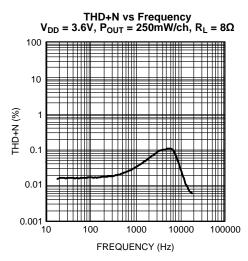


Figure 11.



## TYPICAL PERFORMANCE CHARACTERISTICS (continued)

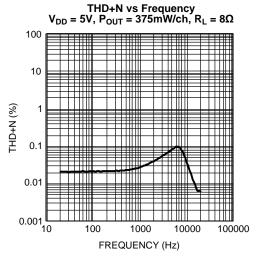


Figure 12.

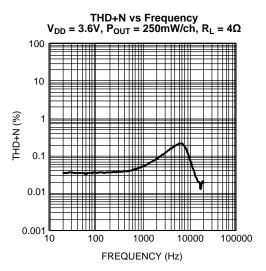
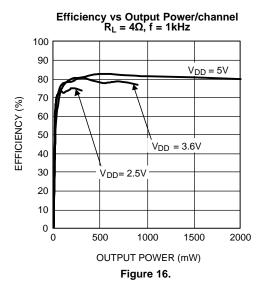


Figure 14.



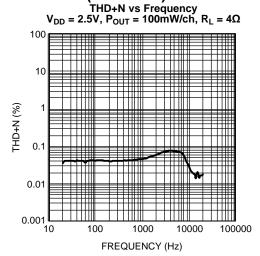


Figure 13.

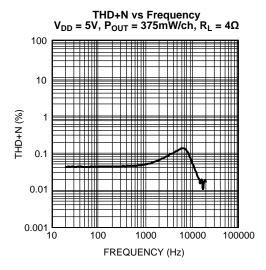


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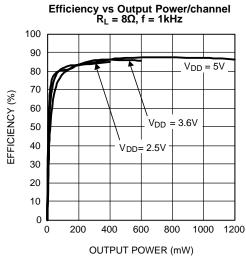


Figure 17.

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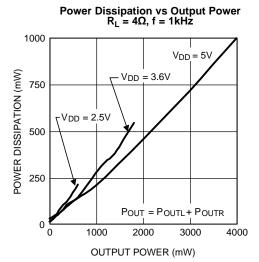
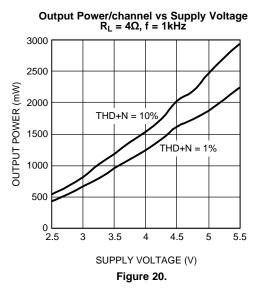


Figure 18.



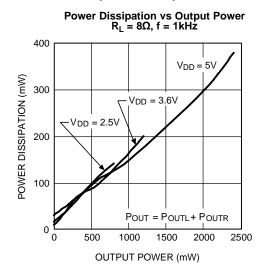
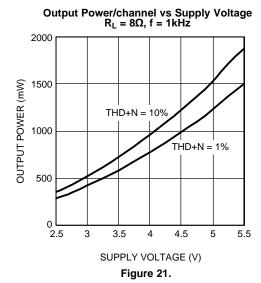


Figure 19.





# TYPICAL PERFORMANCE CHARACTERISTICS (continued)

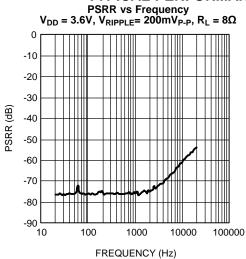


Figure 22.

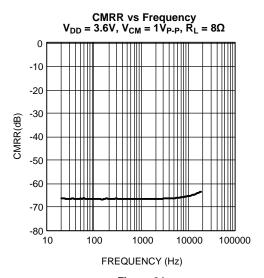


Figure 24.

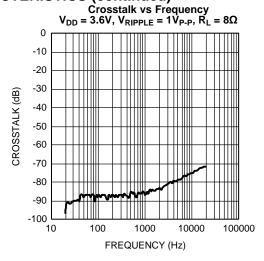
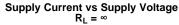


Figure 23.



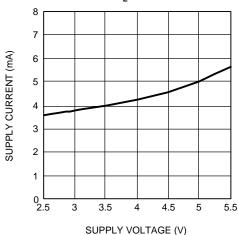


Figure 25.



#### APPLICATION INFORMATION

#### **GENERAL AMPLIFIER FUNCTION**

The LM4674 stereo Class D audio power amplifier features a filterless modulation scheme that reduces external component count, conserving board space and reducing system cost. The outputs of the device transition from  $V_{DD}$  to GND with a 300kHz switching frequency. With no signal applied, the outputs for each channel switch with a 50% duty cycle, in phase, causing the two outputs to cancel. This cancellation results in no net voltage across the speaker, thus there is no current to the load in the idle state.

With the input signal applied, the duty cycle (pulse width) of the LM4674 outputs changes. For increasing output voltage, the duty cycle of the A output increases, while the duty cycle of the B output decreases for each channel. For decreasing output voltages, the converse occurs. The difference between the two pulse widths yields the differential output voltage.

#### DIFFERENTIAL AMPLIFIER EXPLANATION

As logic supplies continue to shrink, system designers are increasingly turning to differential analog signal handling to preserve signal to noise ratios with restricted voltage signs. The LM4674 features two fully differential amplifiers. A differential amplifier amplifies the difference between the two input signals. Traditional audio power amplifiers have typically offered only single-ended inputs resulting in a 6dB reduction of SNR relative to differential inputs. The LM4674 also offers the possibility of DC input coupling which eliminates the input coupling capacitors. A major benefit of the fully differential amplifier is the improved common mode rejection ratio (CMRR) over single ended input amplifiers. The increased CMRR of the differential amplifier reduces sensitivity to ground offset related noise injection, especially important in noisy systems.

#### POWER DISSIPATION AND EFFICIENCY

The major benefit of a Class D amplifier is increased efficiency versus a class AB amplifier. The efficiency of the LM4674 is attributed to the region of operation of the transistors in the output stage. The Class D output stage acts as current steering switches, consuming negligible amounts of power compared to their Class AB counterparts. Most of the power loss associated with the output stage is due to the IR loss of the MOSFET onresistance (R<sub>DS(ON)</sub>), along with switching losses due to gate charge.

#### SHUTDOWN FUNCTION

The LM4674 features independent left and right channel shutdown controls, allowing each channel to be disabled independently. SDR controls the right channel, while SDL controls the left channel. Driving either low disables the corresponding channel.

It is best to switch between ground and  $V_{DD}$  for minimum current consumption while in shutdown. The LM4674 may be disabled with shutdown voltages in between GND and  $V_{DD}$ , the idle current will be greater than the typical 0.03µA value. For logic levels between GND and  $V_{DD}$  bypass SD\_ with a 0.1µF capacitor.

The LM4674 shutdown inputs have internal pulldown resistors. The purpose of these resistors is to eliminate any unwanted state changes when  $\overline{SD}$  is floating. To minimize shutdown current,  $\overline{SD}$  should be driven to GND or left floating. If  $\overline{SD}$  is not driven to GND or floating, an increase in shutdown supply current will be noticed.

## SINGLE-ENDED AUDIO AMPLIFIER CONFIGURATION

The LM4674 is compatible with single-ended sources. When configured for single-ended inputs, input capacitors must be used to block any DC component at the input of the device. Figure 5 shows the typical single-ended applications circuit.

# **AUDIO AMPLIFIER POWER SUPPLY BYPASSING/FILTERING**

Proper power supply bypassing is critical for low noise performance and high PSRR. Place the supply bypass capacitor as close to the device as possible. Typical applications employ a voltage regulator with 10µF and 0.1µF bypass capacitors that increase supply stability. These capacitors do not eliminate the need for bypassing of the LM4674 supply pins. A 1µF capacitor is recommended.

Product Folder Links: LM4674



#### **AUDIO AMPLIFIER INPUT CAPACITOR SELECTION**

Input capacitors may be required for some applications, or when the audio source is single-ended. Input capacitors block the DC component of the audio signal, eliminating any conflict between the DC component of the audio source and the bias voltage of the LM4674. The input capacitors create a high-pass filter with the input resistance Ri. The -3dB point of the high pass filter is found using Equation (1) below.

$$f = 1 / 2\pi R_i C_i \tag{1}$$

The values for Ri can be found in the EC table for each gain setting.

The input capacitors can also be used to remove low frequency content from the audio signal. Small speakers cannot reproduce, and may even be damaged by low frequencies. High pass filtering the audio signal helps protect the speakers. When the LM4674 is using a single-ended source, power supply noise on the ground is seen as an input signal. Setting the high-pass filter point above the power supply noise frequencies, 217 Hz in a GSM phone, for example, filters out the noise such that it is not amplified and heard on the output. Capacitors with a tolerance of 10% or better are recommended for impedance matching and improved CMRR and PSRR.

#### **AUDIO AMPLIFIER GAIN SETTING**

The LM4674 features four internally configured gain settings. The device gain is selected through the two logic inputs, G0 and G1. The gain settings are as shown in the following table.

LOGIC	INPUT	GAIN			
G1	G0	V/V	dB		
0	0	2	6		
0	1	4	12		
1	0	8	18		
1	1	16	24		

#### **PCB LAYOUT GUIDELINES**

As output power increases, interconnect resistance (PCB traces and wires) between the amplifier, load and power supply create a voltage drop. The voltage loss due to the traces between the LM4674 and the load results in lower output power and decreased efficiency. Higher trace resistance between the supply and the LM4674 has the same effect as a poorly regulated supply, increasing ripple on the supply line, and reducing peak output power. The effects of residual trace resistance increases as output current increases due to higher output power, decreased load impedance or both. To maintain the highest output voltage swing and corresponding peak output power, the PCB traces that connect the output pins to the load and the supply pins to the power supply should be as wide as possible to minimize trace resistance.

The use of power and ground planes will give the best THD+N performance. In addition to reducing trace resistance, the use of power planes creates parasitic capacitors that help to filter the power supply line.

The inductive nature of the transducer load can also result in overshoot on one or both edges, clamped by the parasitic diodes to GND and VDD in each case. From an EMI standpoint, this is an aggressive waveform that can radiate or conduct to other components in the system and cause interference. In is essential to keep the power and output traces short and well shielded if possible. Use of ground planes beads and micros-strip layout techniques are all useful in preventing unwanted interference.

As the distance from the LM4674 and the speaker increases, the amount of EMI radiation increases due to the output wires or traces acting as antennas become more efficient with length. Ferrite chip inductors places close to the LM4674 outputs may be needed to reduce EMI radiation.

Product Folder Links: LM4674



# LM4674TL DEMO BOARD SCHEMATIC

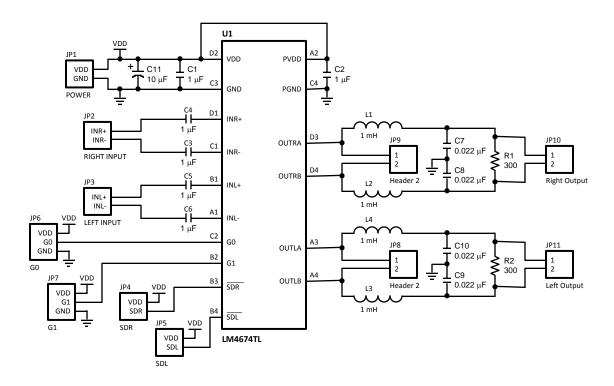


Figure 26. LM4674TL Demo Board Schematic

# **LM4674TL DEMONSTRATION BOARD LAYOUT**

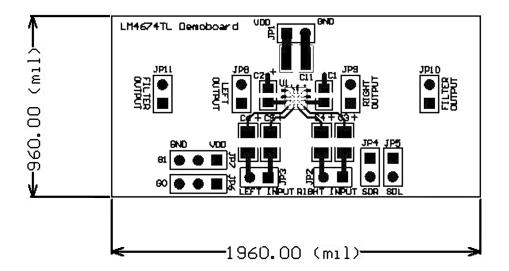


Figure 27. Layer 1



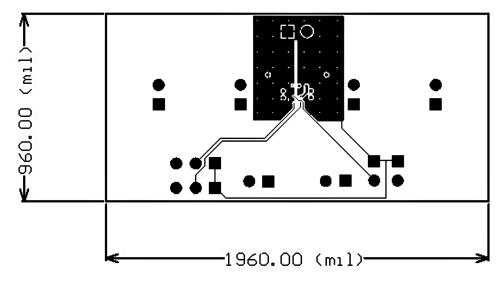


Figure 28. Layer 2

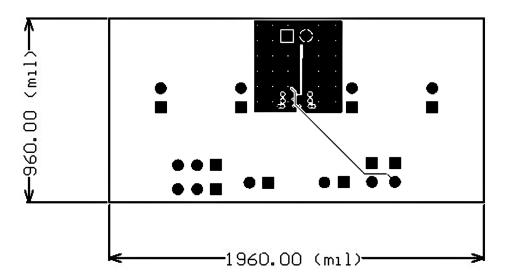


Figure 29. Layer 3



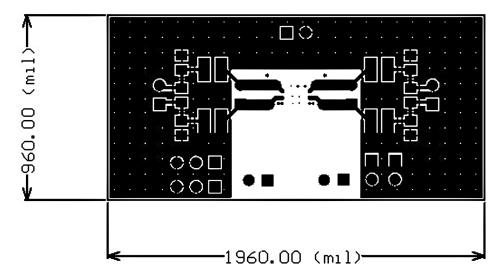


Figure 30. Layer 4

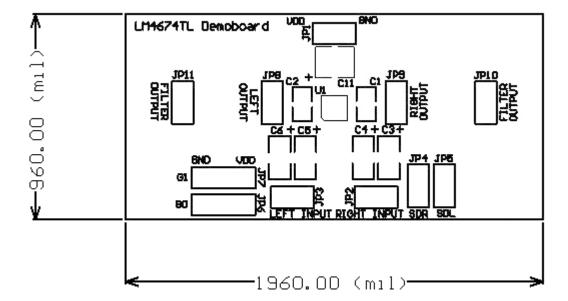


Figure 31. Top Silkscreen



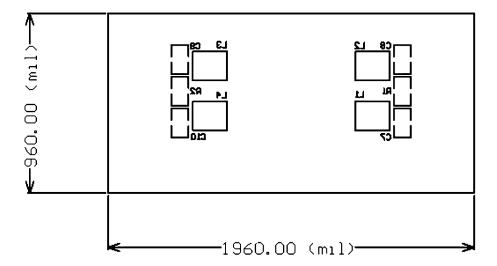


Figure 32. Bottom Silkscreen

# LM4674SQ DEMO BOARD SCHEMATIC

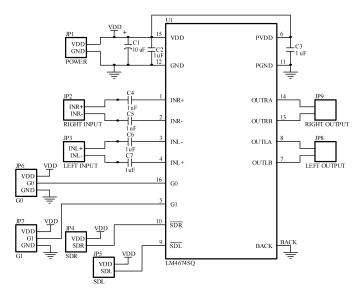


Figure 33. LM4674SQ Demo Board Schematic



# LM4674SQ DEMONSTRATION BOARD LAYOUT

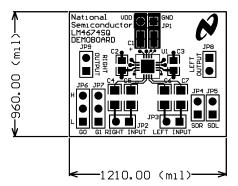


Figure 34. Layer 1

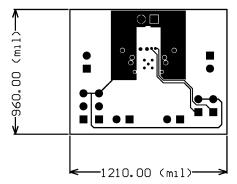


Figure 35. Layer 2

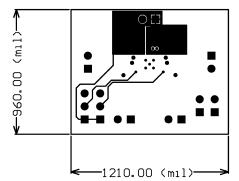


Figure 36. Layer 3



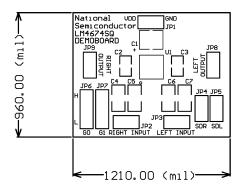


Figure 37. Top Silkscreen

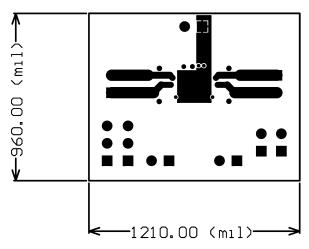


Figure 38. Bottom Layer

# **REVISION TABLE**

Rev	Date	Description
1.0	12/16/06	Initial release.
1.1	05/17/06	Added the LLP package.
1.2	05/31/06	Added the LLP markings.
1.3	09/05/06	Added "No Load" in the Conditions on Av (3.6V table).
1.4	09/21/06	Edited graphics (26, 38, 60) and input some text edits.
1.5	09/27/06	Edited Figure 1 (page 2), TL and LLP pkg/marking drawings (page 3). Input text edits.
1.6	07/13/07	Added the TL and SQ demo boards and schematics diagrams.
1.7	10/30/07	Updated the SQ schematic diagram and replaced the demo boards.
1.8	07/02/08	Text edits (under SHUTDOWN FUNCTION).
Е	04/05/13	Changed layout of National Data Sheet to TI format.

www.ti.com 23-May-2025

#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
LM4674SQ/NOPB	Active	Production	WQFN (RGH)   16	1000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	L4674SQ
LM4674SQ/NOPB.A	Active	Production	WQFN (RGH)   16	1000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	L4674SQ
LM4674TLX/NOPB	Active	Production	DSBGA (YZR)   16	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	GG2
LM4674TLX/NOPB.A	Active	Production	DSBGA (YZR)   16	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	GG2

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

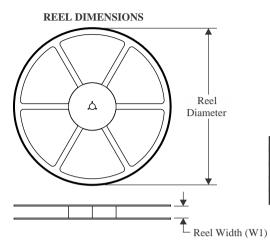
<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

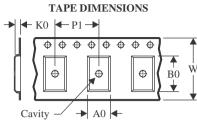
<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 1-Aug-2025

# TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

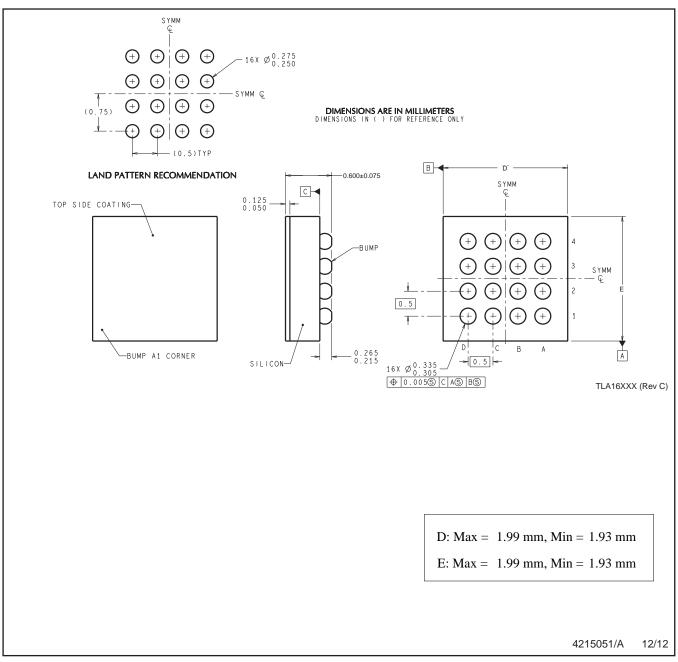
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM4674SQ/N	OPB WQFN	RGH	16	1000	177.8	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LM4674TLX/N	OPB DSBGA	YZR	16	3000	178.0	8.4	2.08	2.08	0.76	4.0	8.0	Q1

www.ti.com 1-Aug-2025



# \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM4674SQ/NOPB	WQFN	RGH	16	1000	208.0	191.0	35.0
LM4674TLX/NOPB	DSBGA	YZR	16	3000	208.0	191.0	35.0

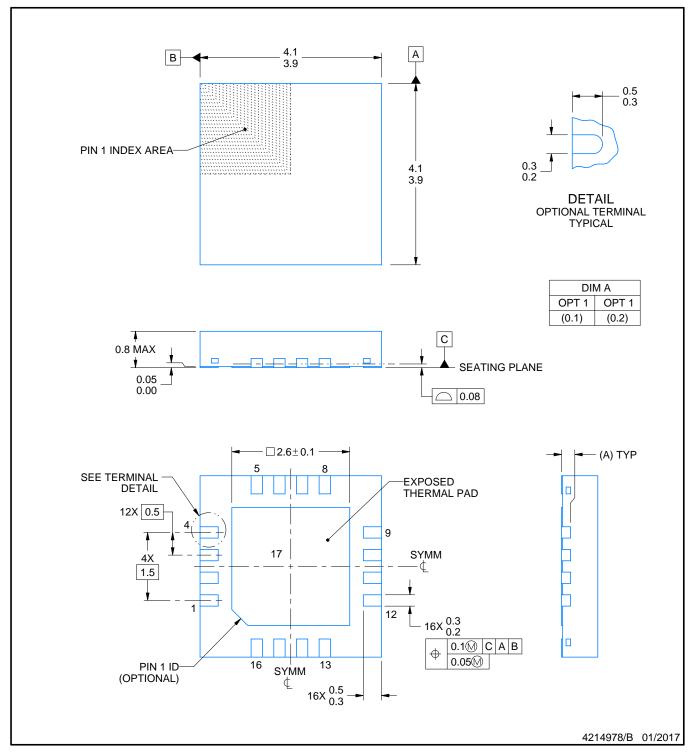


NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

B. This drawing is subject to change without notice.



PLASTIC QUAD FLATPACK - NO LEAD

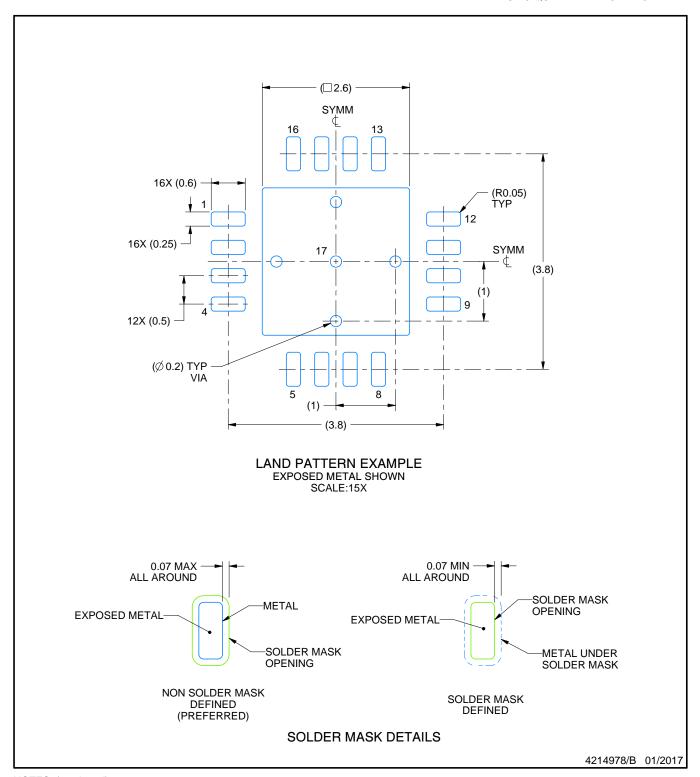


#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.



PLASTIC QUAD FLATPACK - NO LEAD

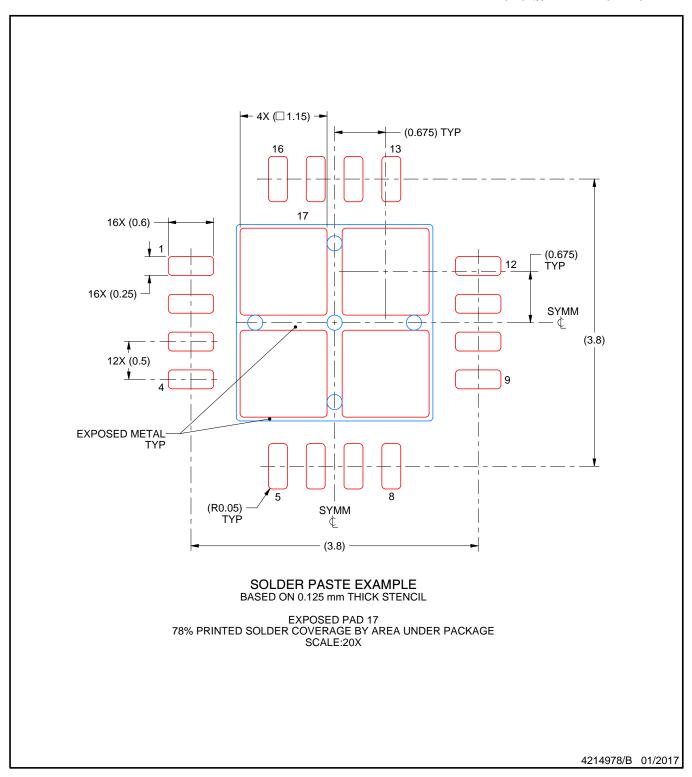


NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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